

**12A 4Quadrants TRIACs**

**Product Summary**

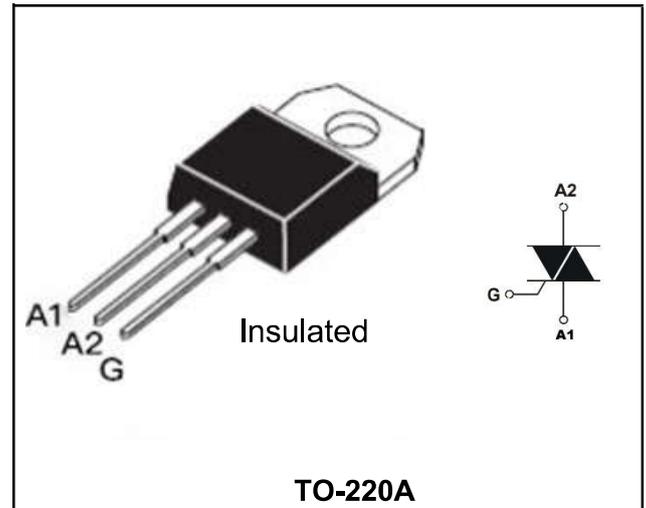
Symbol	Value	Unit
$I_{T(AV)}$	12	A
$V_{DRM} V_{RRM}$	600/800	V
$V_{TM}$	1.55	V

**Features**

NPNP five-layer structure of silicon bidirectional devices; with independent intellectual property rights of single-sided digging technology, table Glass passivation process; multi-layer metallized electrodes on the back; with high blocking voltage and high temperature stability.

**Application**

vacuum cleaners, power tools and other motor speed controllers; solid state relays; heating controllers (temperature regulation); other phase control circuits.



**Absolute maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Repetitive peak off-state voltage	$V_{DRM}$	600/800	V
Repetitive peak reverse voltage	$V_{RRM}$	600/800	V
RMS on-state current	$I_T(RMS)$	12	A
Non repetitive surge peak on-state current (full cycle, F=50Hz)	$I_{TSM}$	120	A
$I^2t$ value for fusing (tp=10ms)	$I^2t$	78	A <sup>2</sup> s
Critical rate of rise of on-state current ( $I_G = 2 \times I_{GT}$ )	$di/dt$	I - II - III	50
		IV	10
Peak gate current	$I_{GM}$	2	A
Average gate power dissipation	$P_G (AV)$	0.5	W
Junction Temperature	$T_J$	-40 ~+125	°C
Storage Temperature	$T_{STG}$	-40 ~+150	°C

**Electrical characteristics (TA=25°C, unless otherwise noted)**

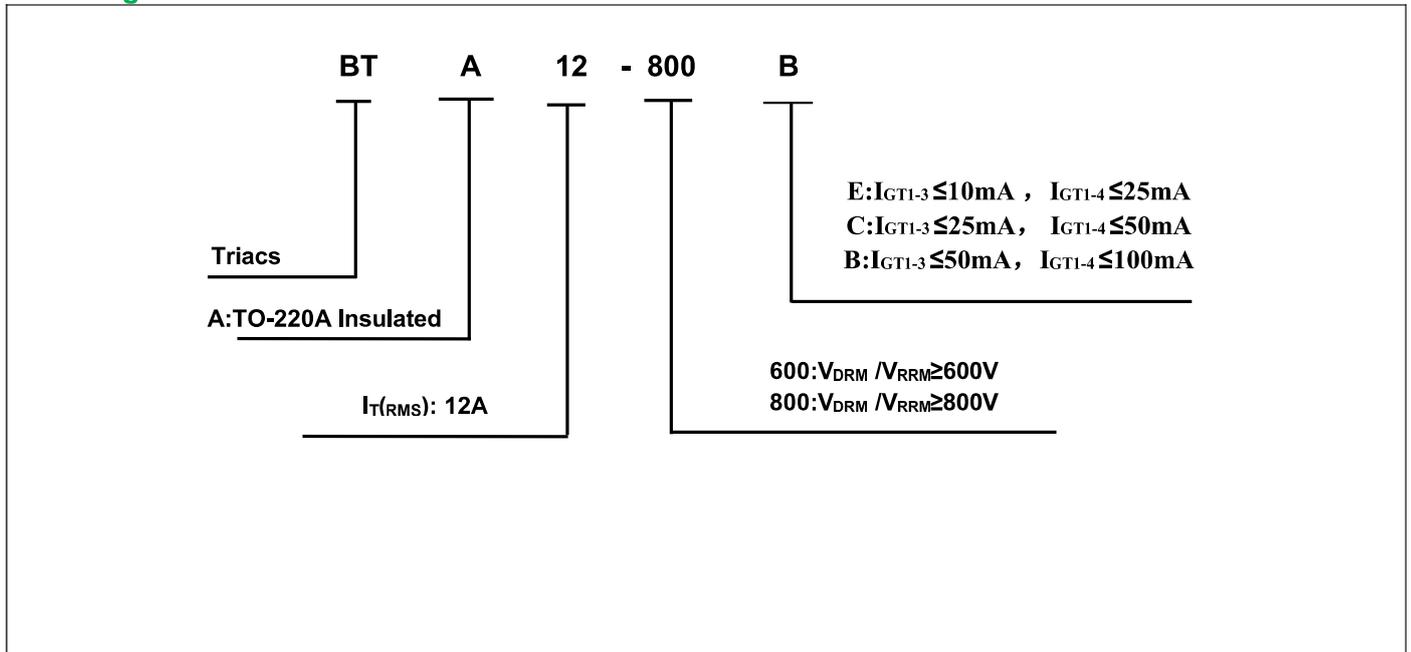
Parameter	Symbol	Test Condition	Value			Unit	
			E	C	B		
Gate trigger current	$I_{GT}$	$V_D=12V$ $I_T=0.1A$ $T_J=25^\circ C$	I-II-III	$\leq 10$	$\leq 25$	$\leq 50$	mA
			IV	$\leq 25$	$\leq 50$	$\leq 100$	
Gate trigger voltage	$V_{GT}$		I-II-III-IV	$\leq 1.3$			V
Gate non-trigger voltage	$V_{GD}$	$V_D = V_{DRM} T_J = 125^\circ C$		$\geq 0.2$			V
Holding current	$I_H$	$V_D=12V$ $I_{GT}=0.1A$ $T_J=25^\circ C$	I-II-III-IV	$\leq 25$	$\leq 30$	$\leq 50$	mA
latching current	$I_L$		I-III-IV	$\leq 30$	$\leq 40$	$\leq 50$	
			II	$\leq 40$	$\leq 60$	$\leq 80$	
Critical-rate of rise of commutation voltage	$dV_D/dt$	$V_D=67\%V_{DRM}, T_J=125^\circ C$		$\geq 100$	$\geq 500$	$\geq 1000$	V/ $\mu s$

**STATIC CHARACTERISTICS**

Forward "on" voltage	$V_{TM}$	$I_{TM} = 17A$ $t_p=380\mu s$		$\leq 1.55$			V
Repetitive Peak Off-State Current	$I_{DRM}$	$V_D=V_{DRM}/V_{RRM}$	$T_J=25^\circ C$	$\leq 5$	$\leq 5$	$\leq 5$	$\mu A$
Repetitive Peak Reverse Current	$I_{RRM}$		$T_J=125^\circ C$	$\leq 1$	$\leq 1$	$\leq 1$	mA

**THERMAL RESISTANCES**

Thermal resistance	$R_{th(j-c)}$	Junction to case(AC)	2.1	$^\circ C/W$
	$R_{th(j-a)}$	Junction to ambient	60	$^\circ C/W$

**Ordering Information**


Typical Characteristics

FIG.1: Maximum power dissipation versus RMS on-state current (full cycle)

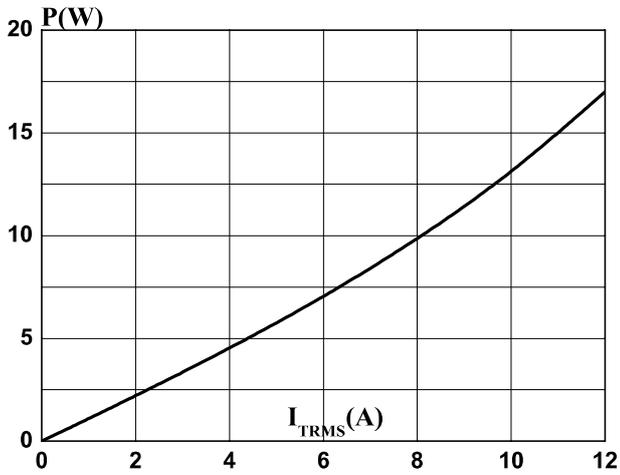


FIG.3: Surge peak on-state current versus number of cycles

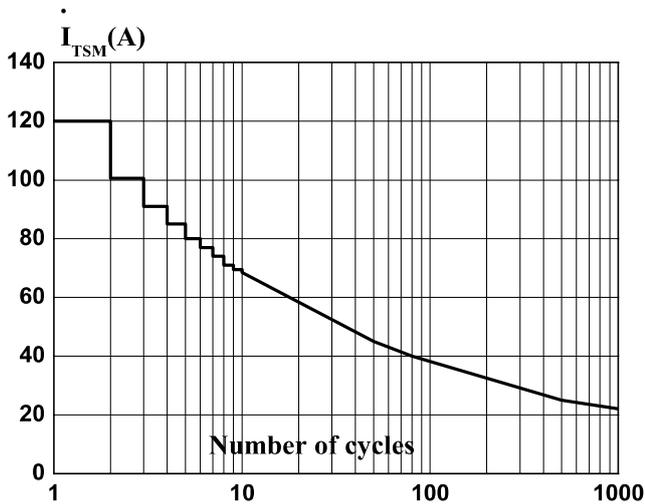


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10\text{ms}$

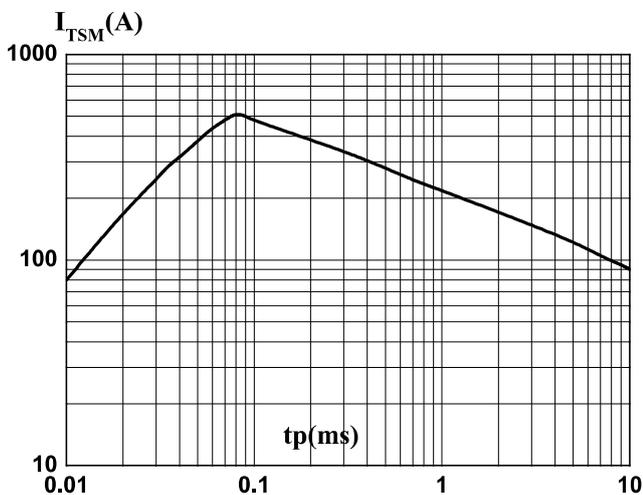


FIG.2: RMS on-state current versus case temperature (full cycle)

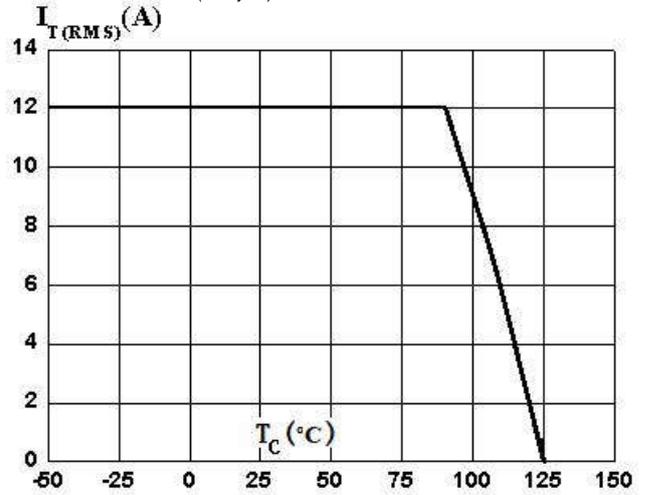


FIG.4: On-state characteristics (maximum values)

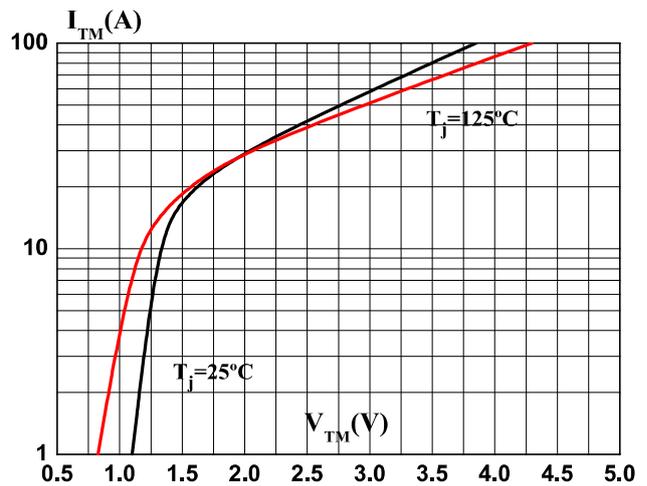
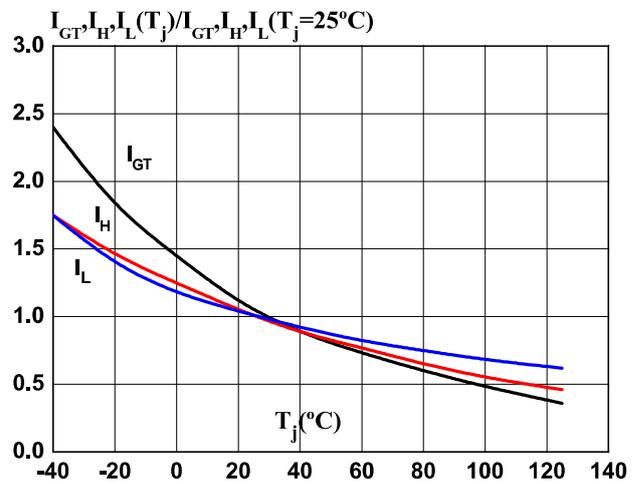
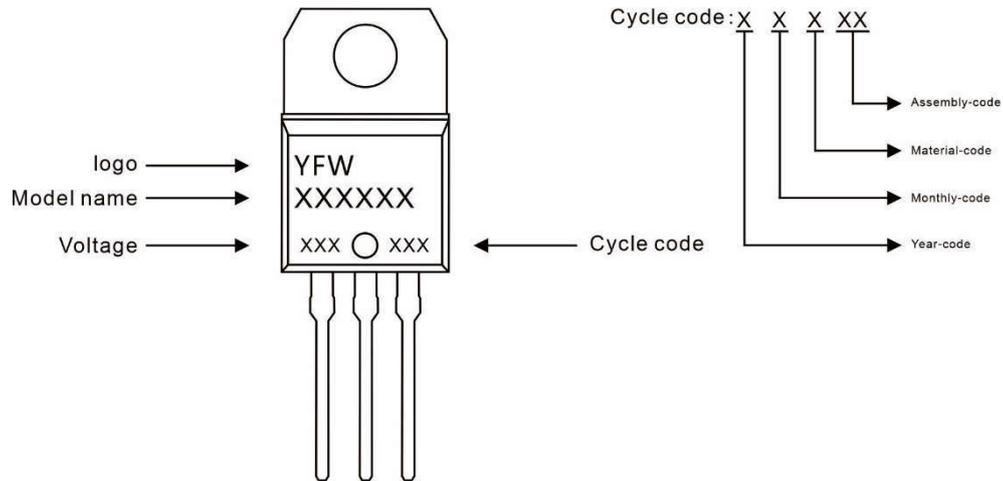


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature (typical values)



**Marking Diagram**



**Ordering information**

Model name	Package	Unit Weight	Base Quantity	Packing Quantity
BTA12	TO-220A	0.07oz(1.96g)	50pcs/tube	1000PCS/Box 5000PCS/Carton

**Package Dimensions**

**TO-220A(Insulated)**

Symbol	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	9.80	10.40	0.386	0.409
B	2.65	3.10	0.104	0.122
C	14.80	16.10	0.583	0.634
D	0.70	0.92	0.028	0.036
D1	1.18	1.42	0.047	0.056
E	2.40	2.70	0.095	0.106
L	2.80	4.20	0.11	0.17
L1	13.05	13.60	0.514	0.535
H	5.85	6.82	0.23	0.27
K	2.35	2.75	0.093	0.108
T	4.38	4.61	0.172	0.181
T1	1.15	1.36	0.045	0.054
T2	0.35	0.65	0.014	0.026
ΦR	3.75	3.95	0.148	0.156

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